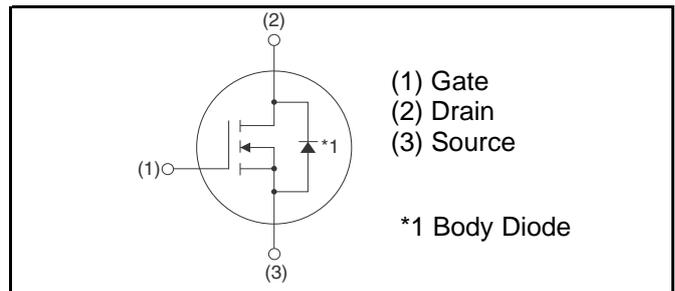


| | |
|---------------------|-------------------|
| V_{DSS} | 1200 |
| $R_{DS(on)}$ (Typ.) | 80m Ω |
| I_D | 40A ^{*1} |

●Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive

●Inner circuit



●Application

- Solar inverters
- DC/DC converters
- Switch mode power supplies
- Induction heating
- Motor drives

●Absolute maximum ratings ($T_a = 25^\circ\text{C}$)

| Parameter | Symbol | Value | Unit |
|--|-------------------------------|-------------|------------------|
| Drain - Source voltage | V_{DSS} | 1200 | V |
| Continuous drain current | I_D ^{*1} | 40 | A |
| Pulsed drain current | $I_{D,pulse}$ ^{*2} | 140 | A |
| Gate - Source voltage (DC) | V_{GSS} | -6 to 22 | V |
| Gate - Source surge voltage ($t_{surge} < 300\text{nsec}$) | $V_{GSS,surge}$ ^{*3} | -10 to 26 | V |
| Junction temperature | T_j | 175 | $^\circ\text{C}$ |
| Range of storage temperature | T_{stg} | -55 to +175 | $^\circ\text{C}$ |

●Electrical characteristics (T_a = 25°C)

| Parameter | Symbol | Conditions | Values | | | Unit |
|---|-----------------------------------|--|--------|------|------|------|
| | | | Min. | Typ. | Max. | |
| Drain - Source breakdown voltage | V _{(BR)DSS} | V _{GS} = 0V, I _D = 1mA | 1200 | - | - | V |
| Zero gate voltage drain current | I _{DSS} | V _{DS} = 1200V, V _{GS} = 0V | - | 1 | 10 | μA |
| | | T _j = 25°C | - | 2 | - | |
| Gate - Source leakage current | I _{GSS+} | V _{GS} = +22V, V _{DS} = 0V | - | - | 100 | nA |
| Gate - Source leakage current | I _{GSS-} | V _{GS} = -6V, V _{DS} = 0V | - | - | -100 | nA |
| Gate threshold voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 4.4mA | 1.6 | 2.8 | 4.0 | V |
| Static drain - source on - state resistance | R _{DS(on)} ^{*4} | V _{GS} = 18V, I _D = 10A | - | 80 | 111 | mΩ |
| | | T _j = 25°C | - | 115 | - | |
| Gate input resistance | R _G | f = 1MHz, open drain | - | 9.0 | - | Ω |

●Electrical characteristics (T_a = 25°C)

| Parameter | Symbol | Conditions | Values | | | Unit |
|--|--------------------------------|--|--------|------|------|------|
| | | | Min. | Typ. | Max. | |
| Transconductance | g_{fs}^{*4} | V _{DS} = 10V, I _D = 10A | - | 3.7 | - | S |
| Input capacitance | C _{iss} | V _{GS} = 0V | - | 2070 | - | pF |
| Output capacitance | C _{oss} | V _{DS} = 800V | - | 80 | - | |
| Reverse transfer capacitance | C _{rss} | f = 1MHz | - | 20 | - | |
| Effective output capacitance, energy related | C _{o(er)} | V _{GS} = 0V V _{DS} = 0V to 800V | - | 99 | - | pF |
| Turn - on delay time | $t_{d(on)}^{*4}$ | V _{DD} = 400V, I _D = 10A | - | 23 | - | ns |
| Rise time | t_r^{*4} | V _{GS} = 18V/0V | - | 39 | - | |
| Turn - off delay time | $t_{d(off)}^{*4}$ | R _L = 40Ω | - | 79 | - | |
| Fall time | t_f^{*4} | R _G = 0Ω | - | 28 | - | |
| Turn - on switching loss | E _{on} ^{*4} | V _{DD} = 600V, I _D = 10A V _{GS} = 18V/0V | - | 255 | - | μJ |
| Turn - off switching loss | E _{off} ^{*4} | R _G = 0Ω, L = 750μH *E _{on} includes diode reverse recovery | - | 27 | - | |

●Gate Charge characteristics (T_a = 25°C)

| Parameter | Symbol | Conditions | Values | | | Unit |
|----------------------|-------------------------------|--|--------|------|------|------|
| | | | Min. | Typ. | Max. | |
| Total gate charge | Q _g ^{*4} | V _{DD} = 400V | - | 110 | - | nC |
| Gate - Source charge | Q _{gs} ^{*4} | I _D = 10A | - | 24 | - | |
| Gate - Drain charge | Q _{gd} ^{*4} | V _{GS} = 18V | - | 38 | - | |
| Gate plateau voltage | V _(plateau) | V _{DD} = 400V, I _D = 10A | - | 9.7 | - | V |

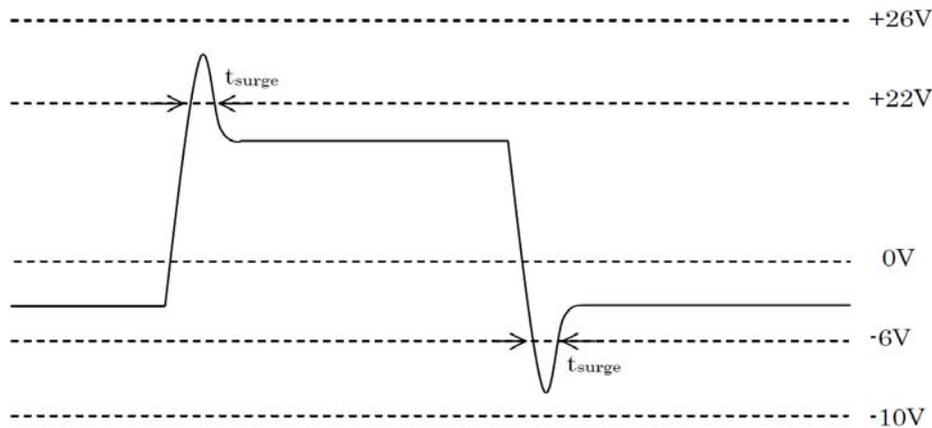
●Body diode electrical characteristics (Source-Drain) ($T_a = 25^\circ\text{C}$)

| Parameter | Symbol | Conditions | Values | | | Unit |
|---|----------------|--|--------|------|------|------|
| | | | Min. | Typ. | Max. | |
| Inverse diode continuous, forward current | I_S^{*1} | $T_c = 25^\circ\text{C}$ | - | - | 40 | A |
| Inverse diode direct current, pulsed | I_{SM}^{*2} | | - | - | 140 | A |
| Forward voltage | V_{SD}^{*4} | $V_{GS} = 0\text{V}, I_S = 10\text{A}$ | - | 4.7 | - | V |
| Reverse recovery time | t_{rr}^{*4} | $I_F = 10\text{A}, V_R = 600\text{V}$ $di/dt = 650\text{A}/\mu\text{s}$ | - | 51 | - | ns |
| Reverse recovery charge | Q_{rr}^{*4} | | - | 194 | - | nC |
| Peak reverse recovery current | I_{rrm}^{*4} | | - | 7.6 | - | A |

*1 For $T_j=175^\circ\text{C}$ and thermal dissipation to ambience of 262W or more.
Limited only by maximum temperature allowed.

*2 $PW \leq 10\mu\text{s}$, Duty cycle $\leq 1\%$

*3 Example of acceptable Vgs waveform



*4 Pulsed

●Electrical characteristic curves

Fig.1 Typical Output Characteristics(I)

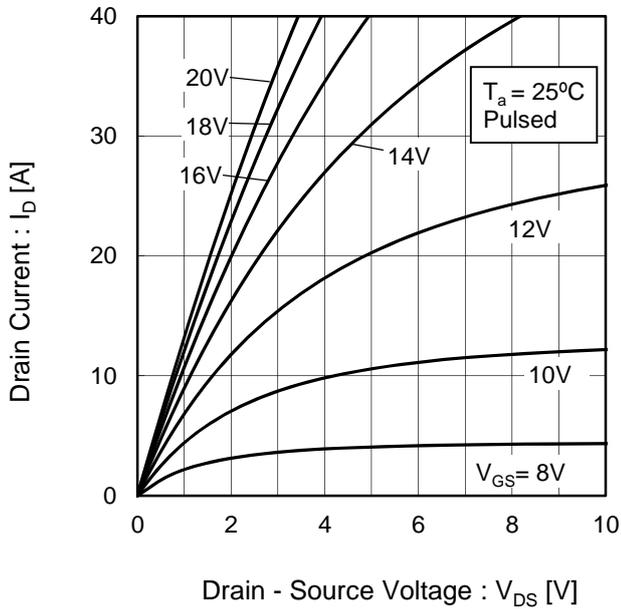


Fig.2 Typical Output Characteristics(II)

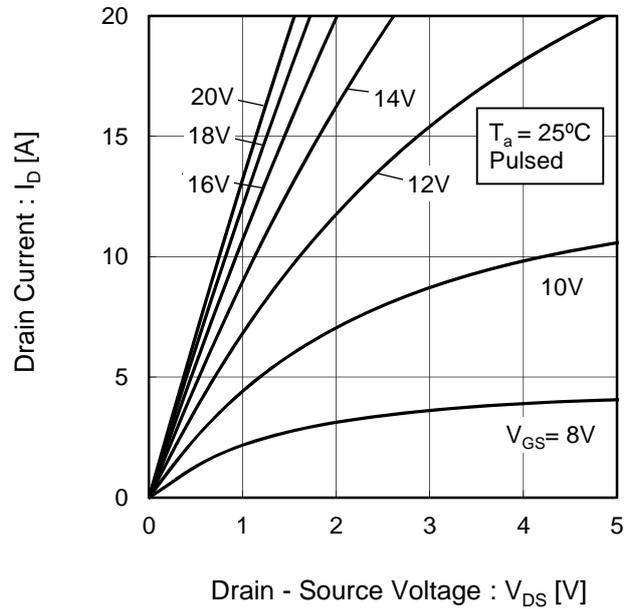


Fig.3 $T_j = 150^\circ\text{C}$ Typical Output Characteristics(I)

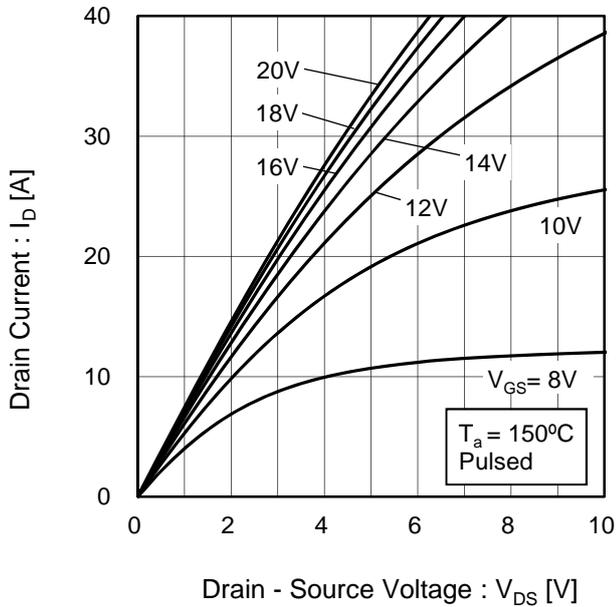
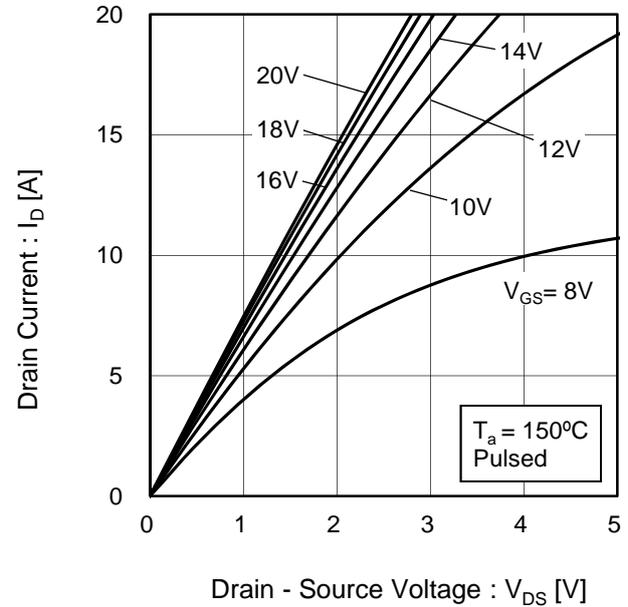


Fig.4 $T_j = 150^\circ\text{C}$ Typical Output Characteristics(II)



●Electrical characteristic curves

Fig.5 Typical Transfer Characteristics (I)

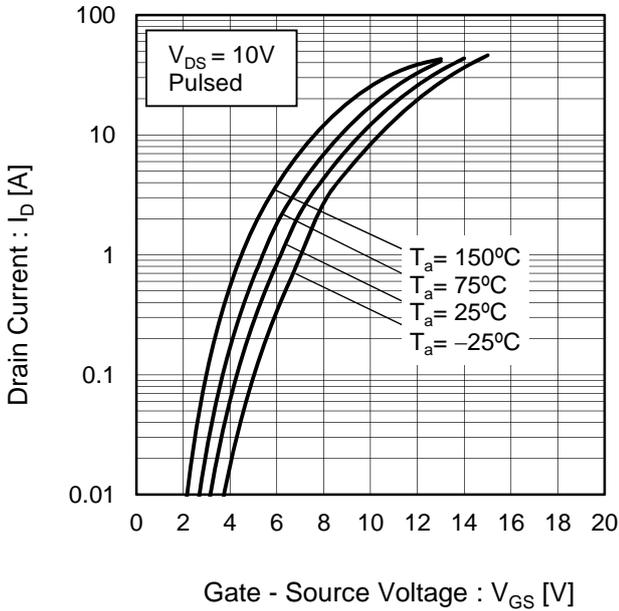


Fig.6 Typical Transfer Characteristics (II)

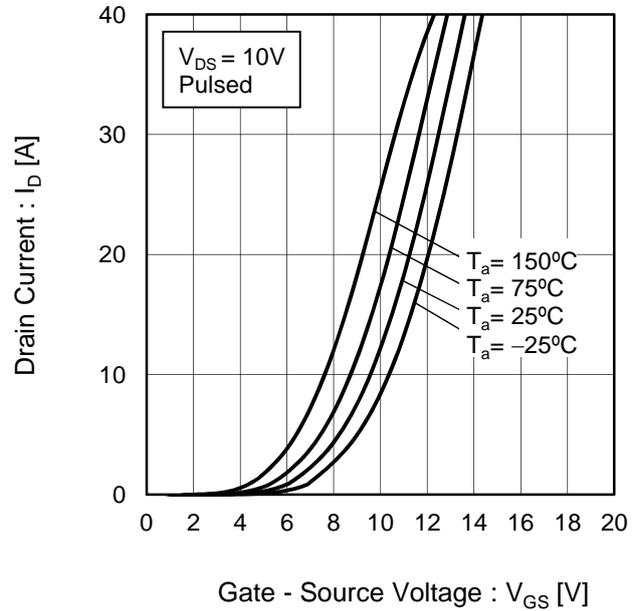


Fig.7 Gate Threshold Voltage vs. Junction Temperature

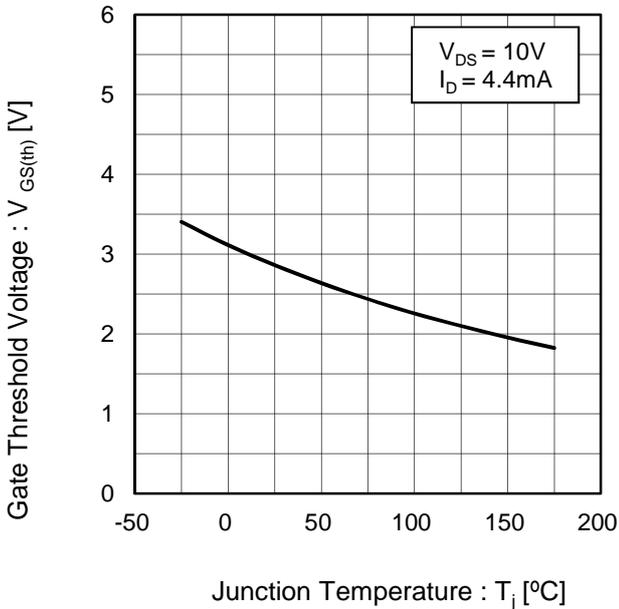
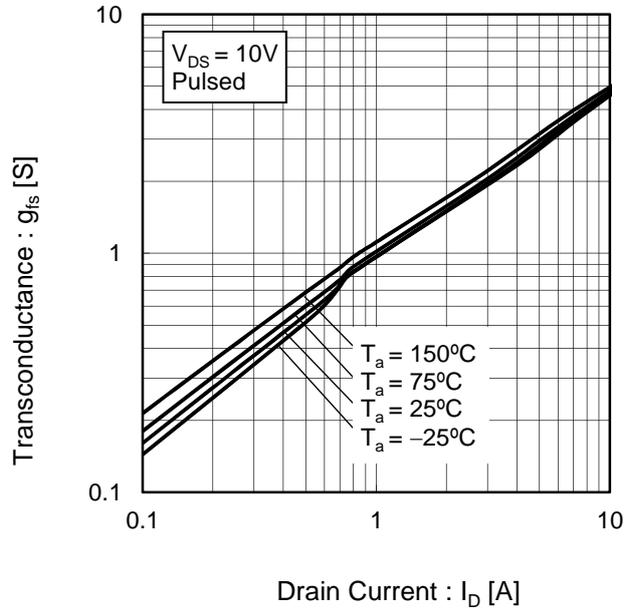


Fig.8 Transconductance vs. Drain Current



●Electrical characteristic curves

Fig.9 Static Drain - Source On - State Resistance vs. Gate - Source Voltage

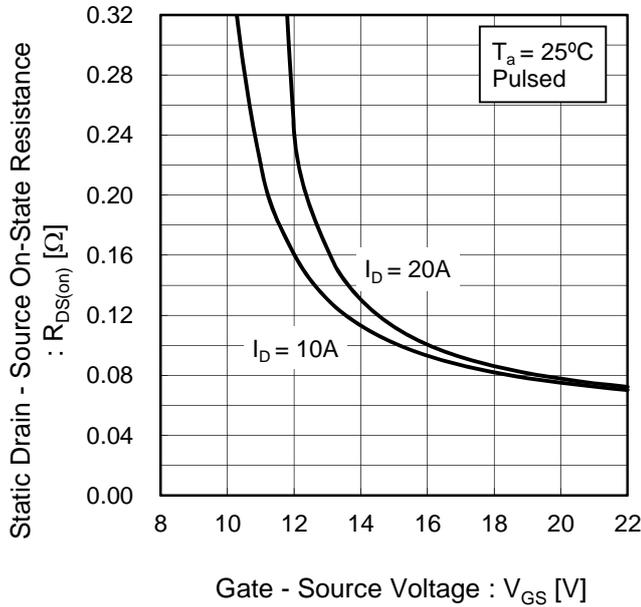


Fig.10 Static Drain - Source On - State Resistance vs. Junction Temperature

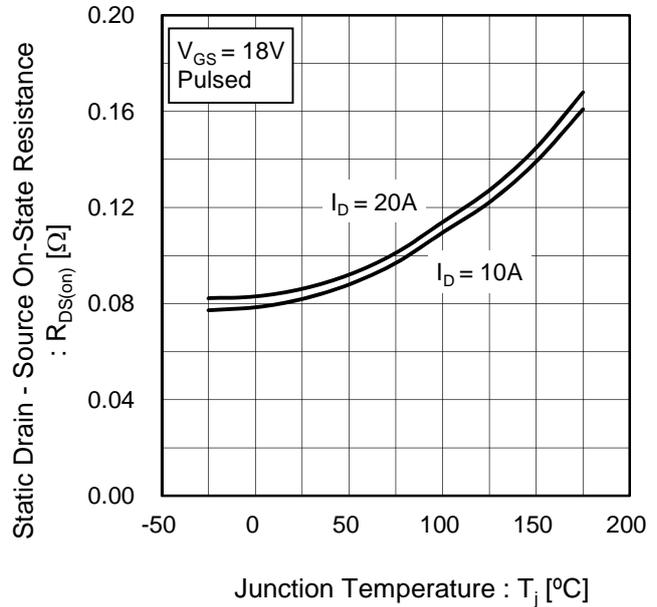
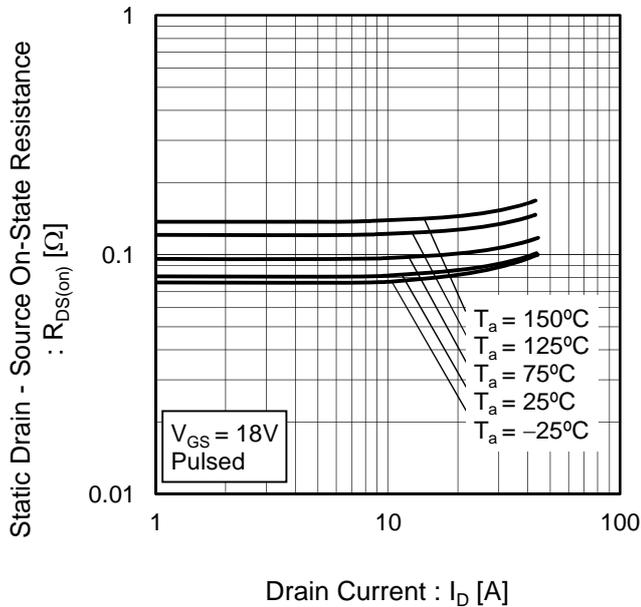


Fig.11 Static Drain - Source On - State Resistance vs. Drain Current



●Electrical characteristic curves

Fig.12 Typical Capacitance vs. Drain - Source Voltage

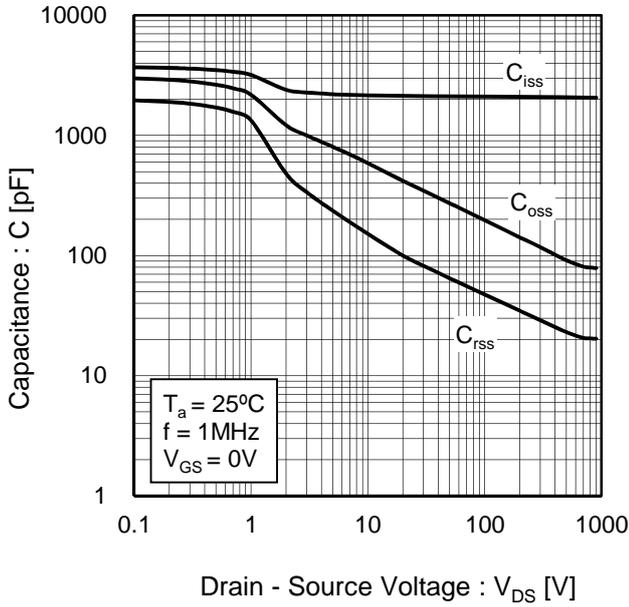


Fig.13 Coss Stored Energy

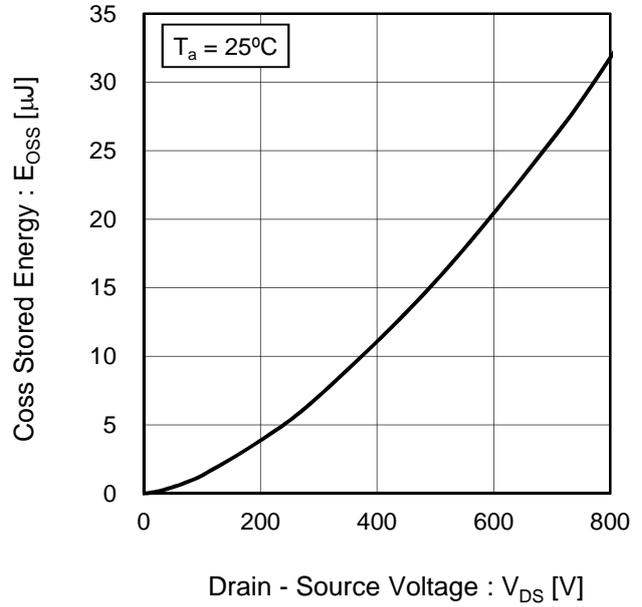


Fig.14 Switching Characteristics

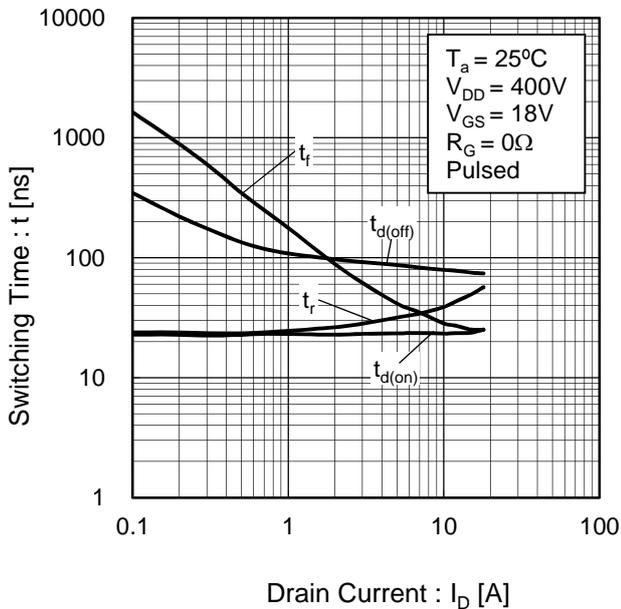
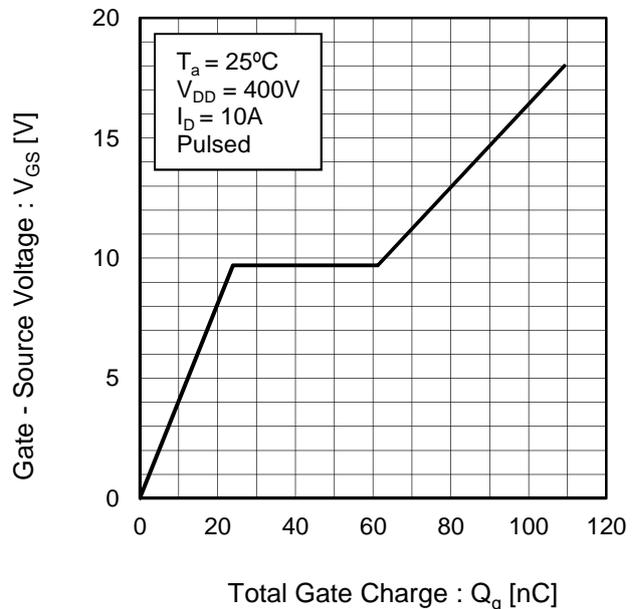


Fig.15 Dynamic Input Characteristics



●Electrical characteristic curves

Fig.16 Typical Switching Loss vs. Drain - Source Voltage

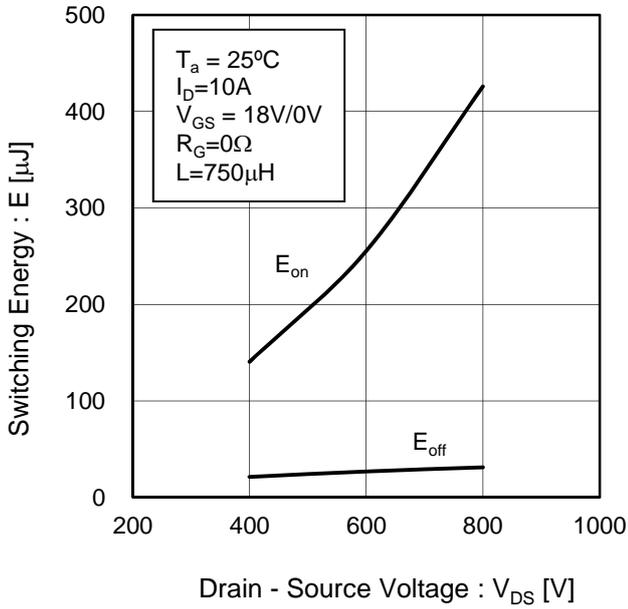


Fig.17 Typical Switching Loss vs. Drain Current

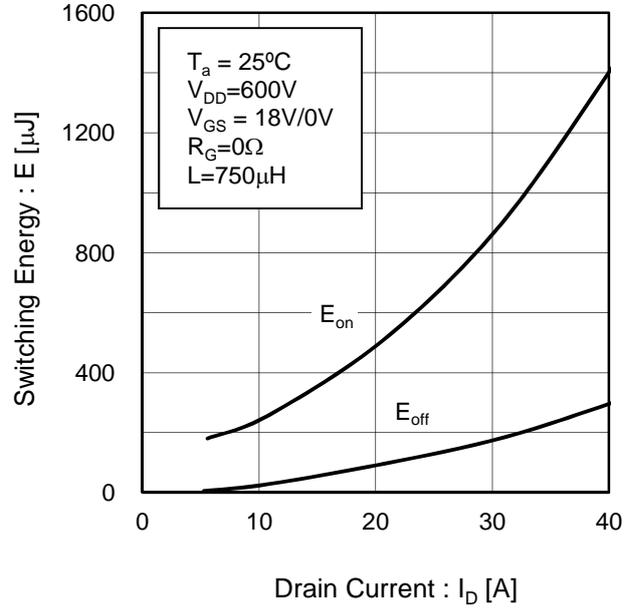
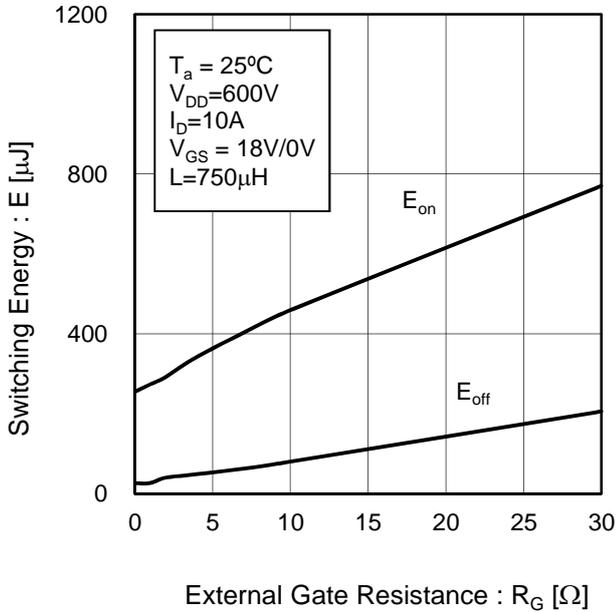


Fig.18 Typical Switching Loss vs. External Gate Resistance



●Electrical characteristic curves

Fig.19 Inverse Diode Forward Current vs. Source - Drain Voltage

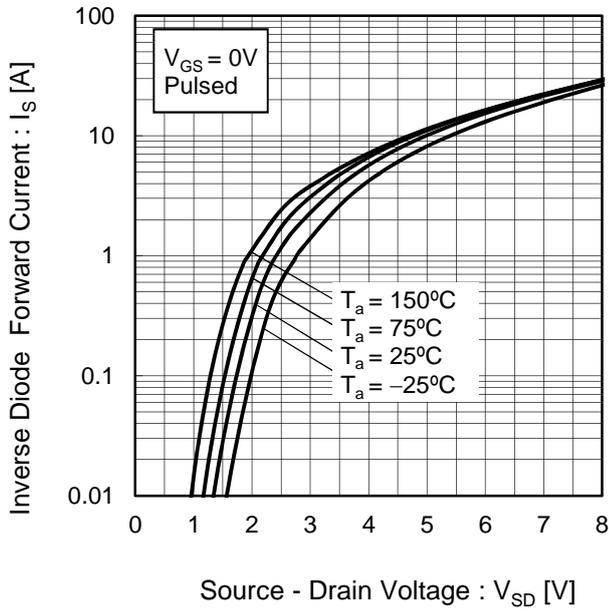
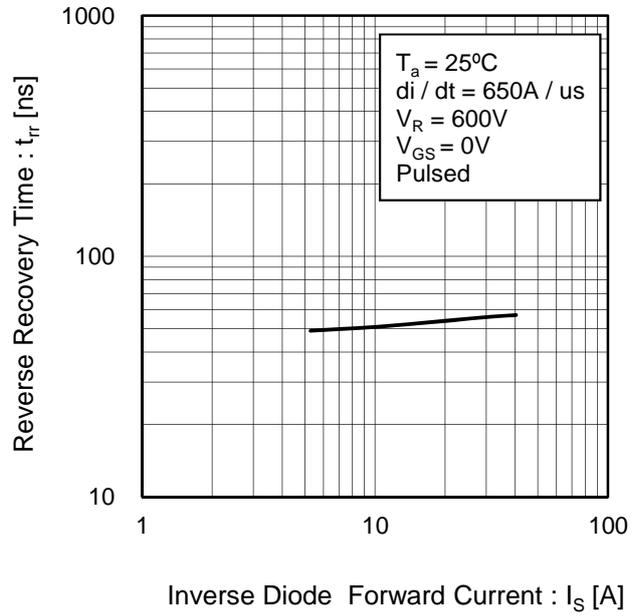


Fig.20 Reverse Recovery Time vs. Inverse Diode Forward Current



● Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

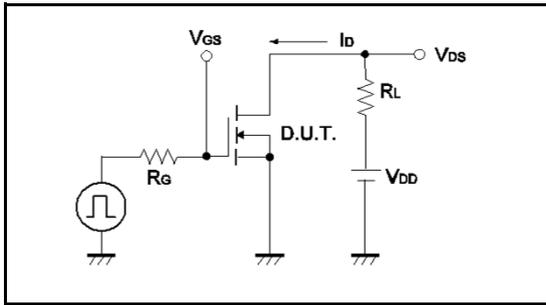


Fig.1-2 Switching Waveforms

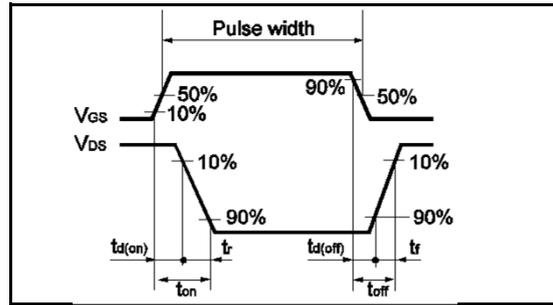


Fig.2-1 Gate Charge Measurement Circuit

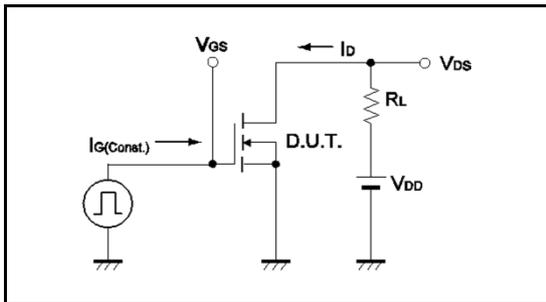


Fig.2-2 Gate Charge Waveform

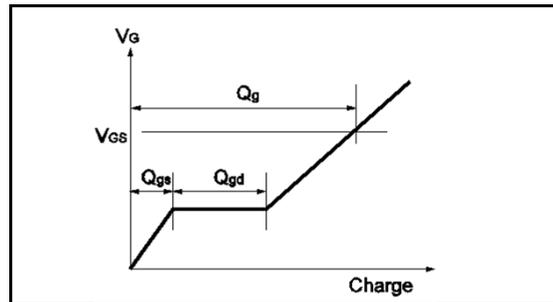


Fig.3-1 Switching Energy Measurement Circuit

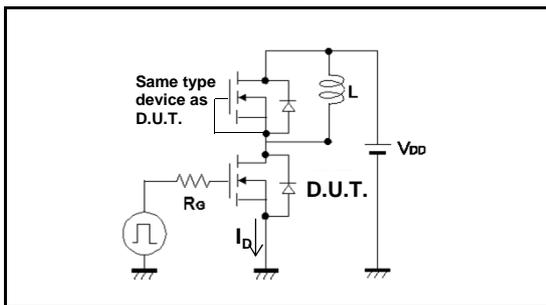


Fig.3-2 Switching Waveforms

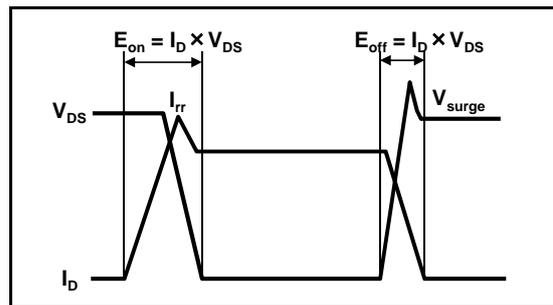


Fig.4-1 Reverse Recovery Time Measurement Circuit

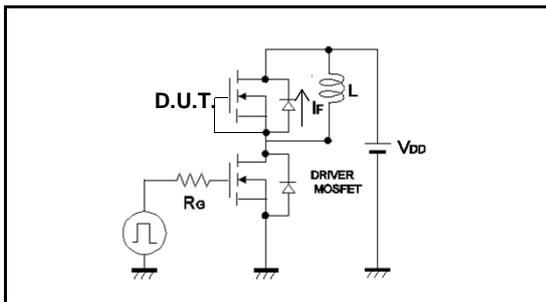
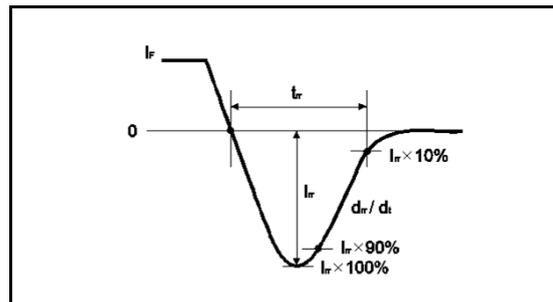


Fig.4-2 Reverse Recovery Waveform



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